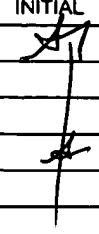

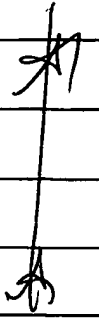



Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY DOCKET NO. 247135US0DIV		SERIAL NO. 10/743,478 <del>New Divisional Application</del>				
LIST OF REFERENCES CITED BY APPLICANT				APPLICANT Geoffrey J. DAVIES, et al.						
				FILING DATE HEREWITH 12/23/2003		GROUP 1722				
U.S. PATENT DOCUMENTS										
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE			
	AA	4,551,316	11/85	Iizuka	7	7				
	AB	5,151,107	09/92	Cho et al.						
	AC	6,270,548	08/01	Campbell et al.						
	AD	6,576,211	06/03	Davies et al.	2	I				
	AE									
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	AG									
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	AK									
	AL									
	AM									
	AN									
	FOREIGN PATENT DOCUMENTS									
			DOCUMENT NUMBER	DATE			COUNTRY	TRANSLATION		
					YES	NO				
	AO	0079117	05/83	Europe						
	AP									
	AQ									
	AR									
	AS									
	AT									
	AU									
	AV									
OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)										
	AW	Hongchang YU et al.; "Sintering of Ultrafine Diamond Particles Under High Temperature and High Pressure"; Diamond and Related Materials, Vol. 3, No. 3, pp. 222-226; 02/01/94								
	AX	Shi Ming HONG et al.; "Diamond Formation from a System of SiC and a Metal"; Diamond and Related Materials, Vol. 2, pp. 508-511; 1993								
	AY	Jae-Kap LEE et al.; "Effect of the Bucyancy Force on Diamond Formation During Synthesis Under a High Pressure"; Vol. 2, pp. 469-499; 03/01/93								
	AZ	A.V. ANDREYEV et al.; "Diamond Formation and Wettability in a Mg-Cu-C System Under High Pressure and High Temperature"; Vol. 6, No. 1, pp. 28-32; 01/1997				<input type="checkbox"/> Additional References sheet(s) attached				
Examiner 					Date Considered 5/05					
*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.										